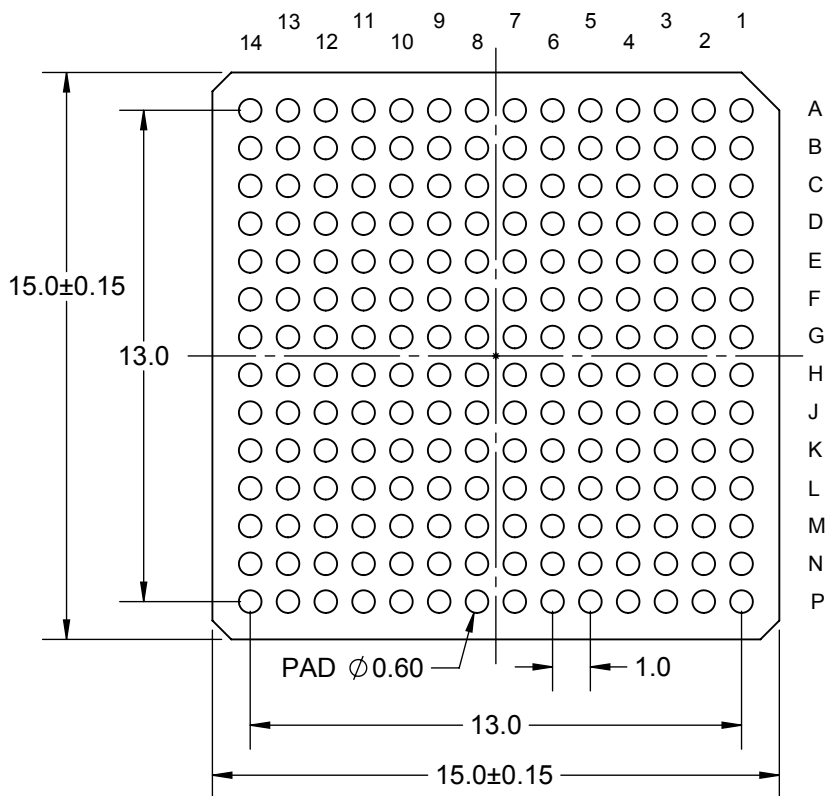
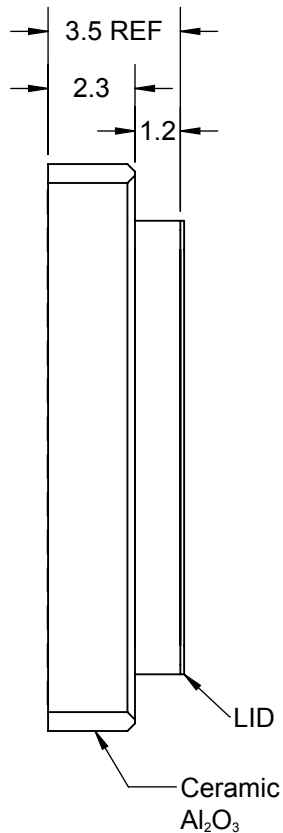


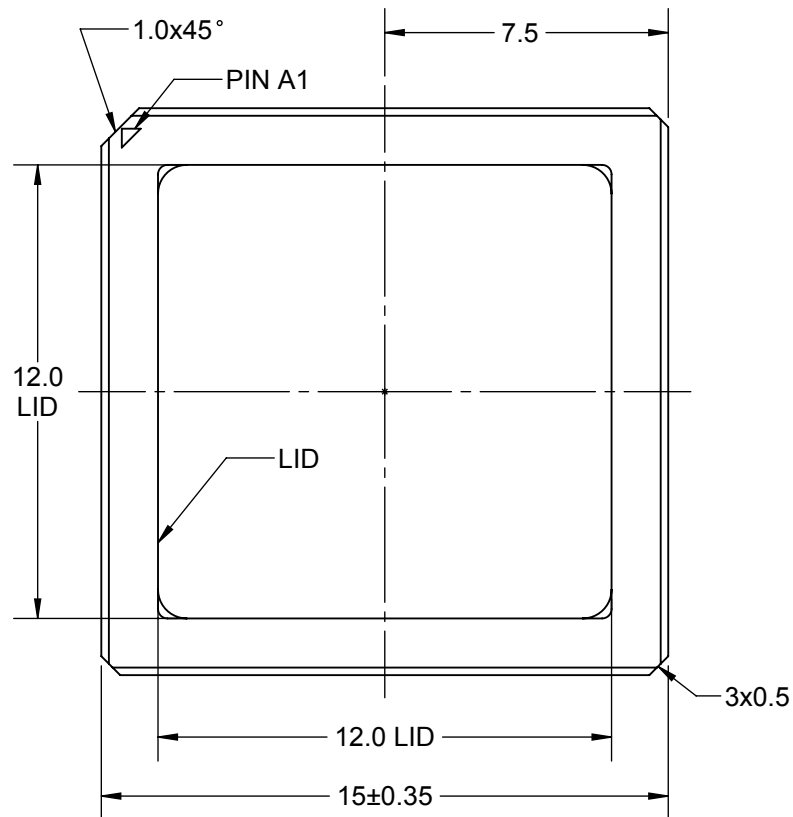
6CHCA J9K



G89 J9K



HCD J9K



NOTES:

1. PLATING TOP

ELECTROLESS Ni 3.20~8.89 µm (125~350 micro-inch).

ELECTROLESS Au 1.5µm Min (60 micro-inch).

2. PLATING BOTTOM

ELECTROLESS Ni 3.20~8.89 µm (125~350 micro-inch).

ELECTROLESS Au 0.25µm Max (10 micro-inch).

Notes: (Unless Otherwise Specified).

1) DIMENSIONS ARE IN mm.

2) SHOWN WITHOUT COLUMNS.

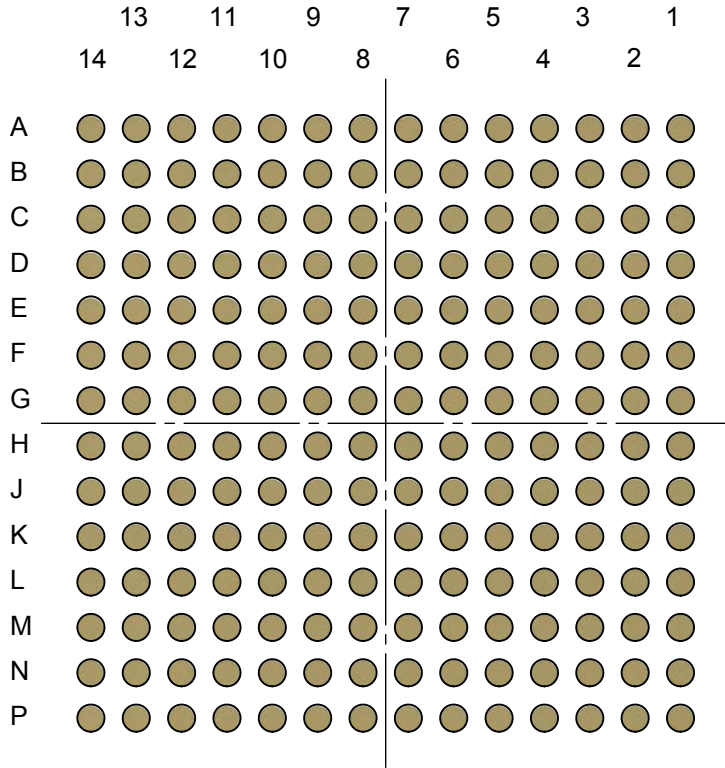
3) SHOWN WITH LID COVER ATTACHED.

D5FHBI A69F CDHCBG			
D5FHBI A69F	89	GC@9F D-B	@8
CLGA1961.0-14x14	YES	NONE	YES

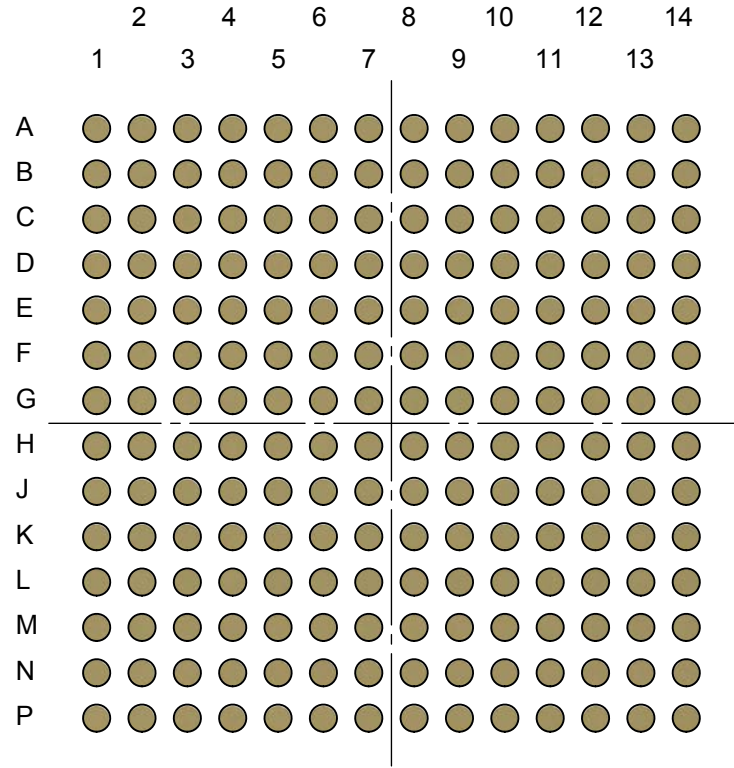
APPROVALS	DATE	TopLine®			
DRAWN T.Au	3/24/2020	TITLE CCGA196T1.0-14x14 COLUMN GRID ARRAY			
ENG M. Hart	3/24/2020				
MFG		SCALE	SIZE	DRAWING NO.	REV
QA		5:1	A	160025	A
CUST		DO NOT SCALE DRAWING			SHEET 1 OF 3
REVISED					

85 =GM7 <5 =B'D5 HH9 FB

7 C @ AB'fD5 8LJ →K

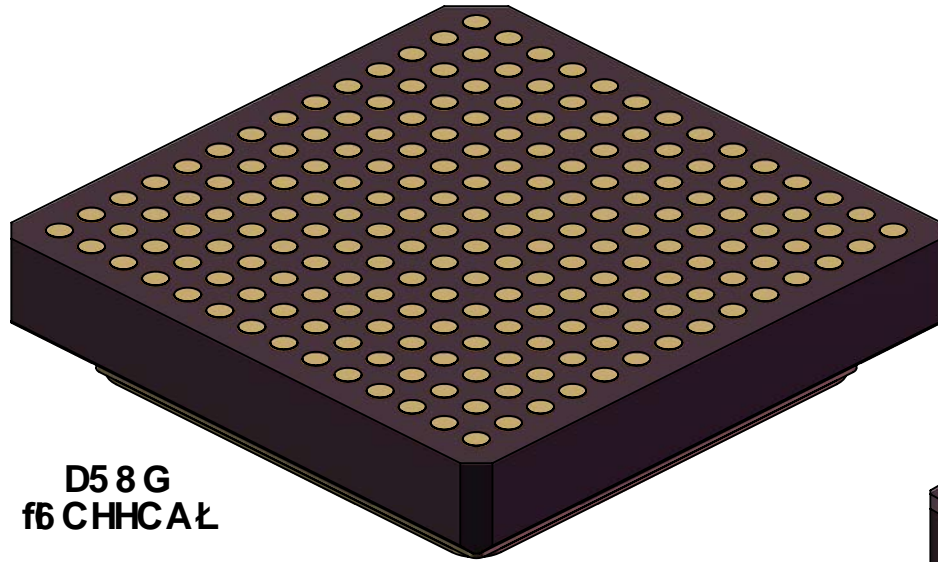


6 CHCA 'L!F5 MJ →K 98 ': FCA 'HCD

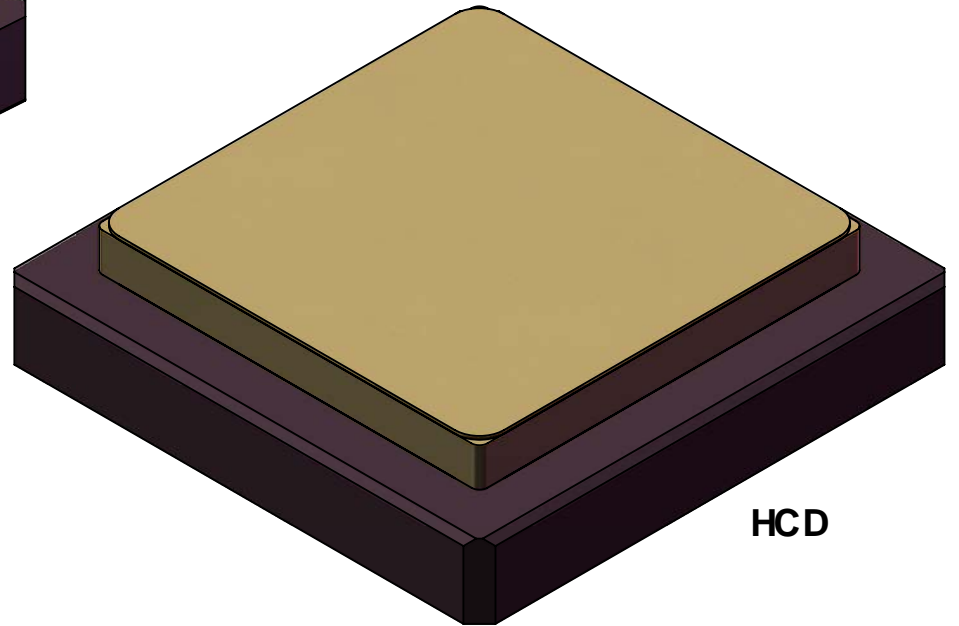


TITLE			
CCGA196T1.0-14x14 COLUMN GRID ARRAY			
SCALE	SIZE	DRAWING NO.	REV
2.5:1	A	160025	A
DO NOT SCALE DRAWING			SHEET 2 OF 3

AC89@
7 @ 5% * H%\$!%1%
@8 '5 HH57 <98



D5 8 G
f6 CHHCAŁ



HCD

TopLine[®]

TITLE CCGA196T1.0-14x14
COLUMN GRID ARRAY

SCALE 6:1	SIZE A	DRAWING NO. 160025	REV A
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DO NOT SCALE DRAWING

SHEET 3 OF 13